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### Low-profile EdgeLine<sup>®</sup> connectors support up to 25 Gbps data rates and are available in multiple orientations and PCB thicknesses for use in high-signal transmissions and high-density signal applications

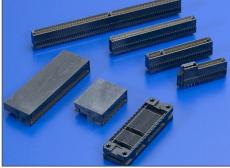
The EdgeLine<sup>®</sup> portfolio encompasses a dynamic group of product families with a compact and clean interface of plated fingers on the edge of a printed circuit board (PCB). These one-piece solutions are cost effective, flexible and scalable solution for low-to-mid range telecom, computing and storage applications.

## **Features and Benefits**

High-speed differential contact design	Provides excellent signal integrity; performance up to 25 Gbps, depending upon the application	
Multiple PCB thicknesses (1.57 to 3.18mm)	Accommodates a variety of PCB thicknesses on complex product designs	
Press-fit, compliant-pin terminal design	Easy board termination using flat- rock tooling	
Cost-effective stitched terminal	Accommodates various signal and power requirements	
Common or singulated ground	Optimizes connector for power and slow-speed, single-ended signals in addition to high-speed differential circuits	
Center key available on certain circuit sizes	Improves PCB alignment during mating by relaxing board tolerances up to 0.80mm pitch	
Multiple circuit sizes available	Design flexibility for signal and power assignment	
Low-profile heights: CoPlanar Connector 6.40mm above PCB; CoEdge Connector 3.50mm above and below PCB	Enhanced air flow and thermal management	
Keying and locking features available (0.80mm pitch CoEdge Connectors only)	Secures the connector to the PCB and improves board alignment during mating	
Secondary locking options available (0.80mm pitch CoEdge Connectors only)	Prevents accidental unmating and prevents PCB from backing out of connector	

# EdgeLine<sup>®</sup> High-Speed Edge Card Connectors

- 171774 Edge Card Connectors, 25 Gbps, Multiple Circuit Sizes, Vertical Insertion
- **151001** Edge Card Connectors, 15 Gbps, Multiple Circuit Sizes, Vertical Insertion
- **76421** Edge Card Connectors, 12.5 Gbps, 108 Circuits, Vertical Insertion
- **76691** Edge Card **170673** Connectors, 12.5 Gbps,
- **76693** Multiple Circuit **170672** Sizes, Vertical Insertion
- **76861** Signal Power (ESP) Connectors, 12.5 Gbps, 46 Circuits, Vertical Insertion, 2 Power Blades
- 76291 CoPlanar Connectors, 12.5 Gbps, Multiple Circuit Sizes, Right-Angle Insertion
- **46720** CoEdge Connectors, 12.5 Gbps, Dual Sided, Multiple Circuit Sizes, Midplane Insertion



EdgeLine® Connectors

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## **Specifications**

#### **Reference Information**

Packaging: Trav UL File No.: ECBT2.E29179 CSA File No.: TBD Mates With: Plug-in Card Product Specification: EdgeLine 25 Gpbs Connectors: PS-171774-0001 EdgeLine CoEdge Connectors: PS-46720-001 EdgeLine CoPlanar Connectors: PS-761291-001 EdgeLine 12.5 Gbps Edge Card and Signal Power (ESP) Connectors: PS-76861-100 EdgeLine Edge Card Connectors: PS-75594-999

#### Electrical

Voltage (max.): EdgeLine 25 Connectors: 250V AC EdgeLine CoEdge Connectors: 240 VAC EdgeLine CoPlanar Connectors: 50 VAC (RMS)/DC EdgeLine (ESP) Connectors: 250V AC(RMS)/DC EdgeLine Edge Card Connectors: 250V AC Current (max.): EdgeLine 25 Connector: 1.52A EdgeLine CoEdge Connector: 1.0A EdgeLine CoPlanar Connector: 1.5A EdgeLine (ESP) Connector: 30A EdgeLine Edge Card Connectors: 1.5A Contact Resistance (max.): 10 milliohms Dielectric Withstanding Voltage: 300V AC Insulation Resistance (min.): 10 Megohms

# EdgeLine<sup>®</sup> High-Speed Edge Card Connectors

Mechanical Durability (min.): 200 cycles

#### Physical

Housing: Glass Filled Thermoplastic, 94-VO, Black Contact: Copper (Cu) Alloy Plating: Contact Area — 0.76µmGold (Au) min. Solder Tail Area -0.76µm to 1.52µmTin (Sn) Underplating — 1.27µmNickel (Ni) min. **Operating Temperature:** EdgeLine 25 Connector: -40°C to +105°C EdgeLine CoEdge Connector: -55°C to +85°C EdgeLine CoPlanar Connector: -40°C TO +85C EdgeLine (ESP) Connector: -40°C to +105°C EdgeLine Edge Card Connectors: -40°C to +105°C

## **Applications**

Telecommunications hardware Storage Networking equipment Computing systems PCIe SAS SATA Storage systems

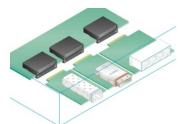




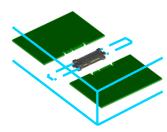
High-End Servers



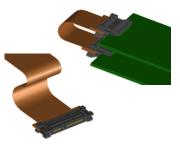
EdgeLine<sup>®</sup> Edge Card Connector Application



EdgeLine<sup>®</sup> CoEdge Mid-plane Connector Application



EdgeLine<sup>®</sup> CoPlanar Modular Connector Application



EdgeLine<sup>®</sup> CoEdge Flex Cable Connector Application

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## **Ordering Information**

# EdgeLine<sup>®</sup> High-Speed Edge Card Connectors

Order Number	Component	Data Rate	Circuits	Pitch	PCB Thickness
46720-0011			108		1.57mm
46720-0016	CoEdge Connector			0.80mm	1.57 to 2.50mm
46720-0041			200		3.18mm
76291-0038	CoPlanar Connector	12 Gbps	38	0.75mm	1.57mm
76291-0068			68		
76291-0140			140		
76291-0170			170		
76291-0226		-	226		
76291-0250		-	250		
76421-1000			108		1.57mm
76691-1046		-	46	0.80mm	
76691-1200			200		
76691-2080		-	80		
76691-2108			108		
76691-3108			108		
76693-1170	_	-	170		2.36mm
76693-1200	-	_	200		
76693-2274			294		
76693-2278			278		
76693-2294	_		294		
76693-3170	Edge Card	12 Gbps	170		
76861-1000	Edge Card Connector	-	46 signal pins plus 2 power blades		
76861-1120	_		56 signal pins plus 2 power blades		
170672-1170	-		170		
170672-1200	_		200		
170672-2278			278		
170673-1046		46	-		
170673-1200		200			
170673-2080		15 Gbps	80		1.57mm
170673-2108			108		
170673-2278			278		
151001-2118	1			1	1.57mm
171774-2118	1	25 Gbps	118		

### www.molex.com/link/edgeline.html